

# **2SK1303** Silicon N Channel MOS FET

REJ03G0922-0200 (Previous: ADE-208-1261) Rev.2.00 Sep 07, 2005

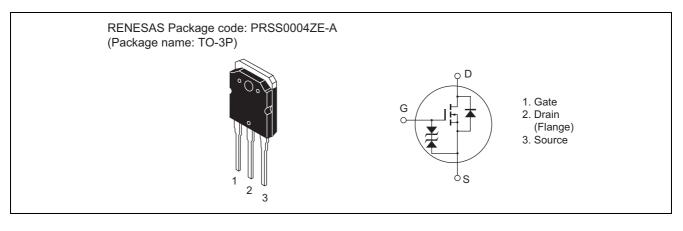
### Application

High speed power switching

### Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device
- Can be driven from 5 V source
- Suitable for motor drive, DC-DC converter, power switch and solenoid drive

### Outline





# Absolute Maximum Ratings

| (1a - 25 C) | (Ta | = | 25° | C) |
|-------------|-----|---|-----|----|
|-------------|-----|---|-----|----|

| Item                                      | Symbol                   | Ratings     | Unit |
|---|--------------------------|-------------|------|
| Drain to source voltage                   | V <sub>DSS</sub>         | 100         | V    |
| Gate to source voltage                    | V <sub>GSS</sub>         | ±20         | V    |
| Drain current                             | ID                       | 30          | А    |
| Drain peak current                        | I <sub>D(pulse)</sub> *1 | 120         | А    |
| Body to drain diode reverse drain current | I <sub>DR</sub>          | 30          | А    |
| Channel dissipation                       | Pch <sup>*2</sup>        | 100         | W    |
| Channel temperature                       | Tch                      | 150         | °C   |
| Storage temperature                       | Tstg                     | -55 to +150 | °C   |

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. Value at  $T_C = 25^{\circ}C$ 

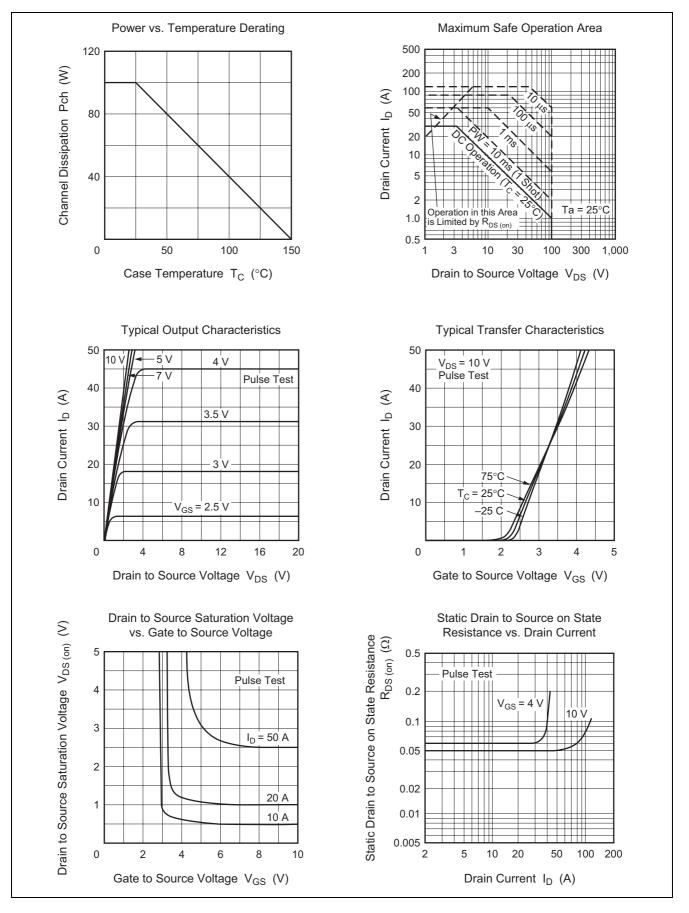
# **Electrical Characteristics**

|                                      |                      |     |      |      |      | (Ta = 25°C)                                      |
|--------------------------------------|----------------------|-----|------|------|------|--|
| ltem                                 | Symbol               | Min | Тур  | Max  | Unit | Test conditions                                  |
| Drain to source breakdown voltage    | V <sub>(BR)DSS</sub> | 100 | —    | _    | V    | $I_D = 10 \text{ mA}, V_{GS} = 0$                |
| Gate to source breakdown voltage     | V <sub>(BR)GSS</sub> | ±20 | —    | _    | V    | $I_G = \pm 100 \ \mu A, \ V_{DS} = 0$            |
| Gate to source leak current          | I <sub>GSS</sub>     | _   | _    | ±10  | μA   | $V_{GS} = \pm 16 V, V_{DS} = 0$                  |
| Zero gate voltage drain current      | I <sub>DSS</sub>     | _   | —    | 250  | μA   | $V_{DS} = 80 V, V_{GS} = 0$                      |
| Gate to source cutoff voltage        | V <sub>GS(off)</sub> | 1.0 | _    | 2.0  | V    | $I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$      |
| Static drain to source on state      | R <sub>DS(on)</sub>  | _   | 0.05 | 0.06 | Ω    | $I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$ |
| resistance                           |                      | _   | 0.06 | 0.09 | Ω    | $I_D = 15 \text{ A}, V_{GS} = 4 \text{ V}^{*3}$  |
| Forward transfer admittance          | y <sub>fs</sub>      | 13  | 22   | _    | S    | $I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$ |
| Input capacitance                    | Ciss                 |     | 1750 | _    | pF   | $V_{DS} = 10 V, V_{GS} = 0,$                     |
| Output capacitance                   | Coss                 |     | 710  | _    | pF   | f = 1 MHz  |
| Reverse transfer capacitance         | Crss                 |     | 180  | _    | pF   |  |
| Turn-on delay time                   | t <sub>d(on)</sub>   |     | 15   | _    | ns   | $I_D = 15 \text{ A}, V_{GS} = 10 \text{ V},$     |
| Rise time                            | tr                   | _   | 120  | _    | ns   | $R_L = 2 \Omega$                                 |
| Turn-off delay time                  | t <sub>d(off)</sub>  | _   | 390  | _    | ns   |  |
| Fall time                            | t <sub>f</sub>       | _   | 195  | _    | ns   |  |
| Body to drain diode forward voltage  | $V_{DF}$             | _   | 1.3  | _    | V    | $I_F = 30 \text{ A}, V_{GS} = 0$                 |
| Body to drain diode reverse recovery | t <sub>rr</sub>      | _   | 360  | _    | ns   | $I_F = 30 \text{ A}, V_{GS} = 0,$                |
| time                                 |                      |     |      |      |      | di <sub>F</sub> /dt = 50 A/µs                    |

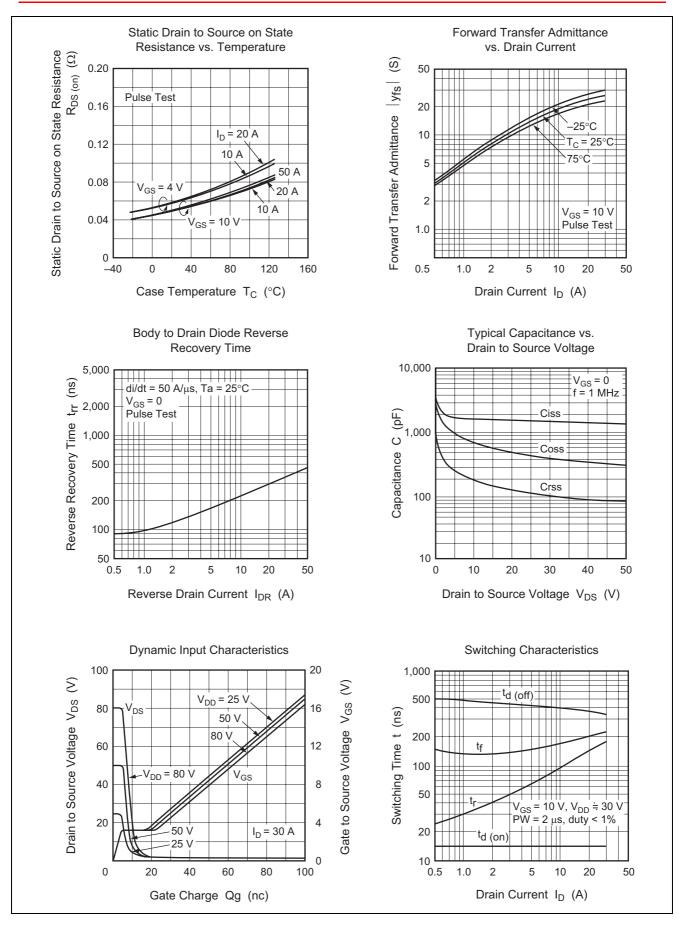
Note: 3. Pulse test



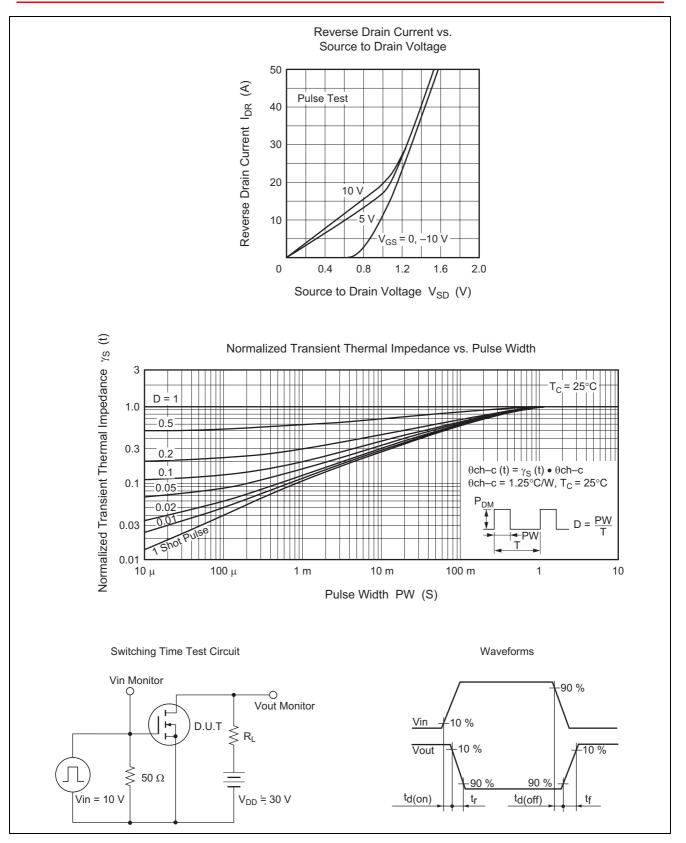
### **Main Characteristics**





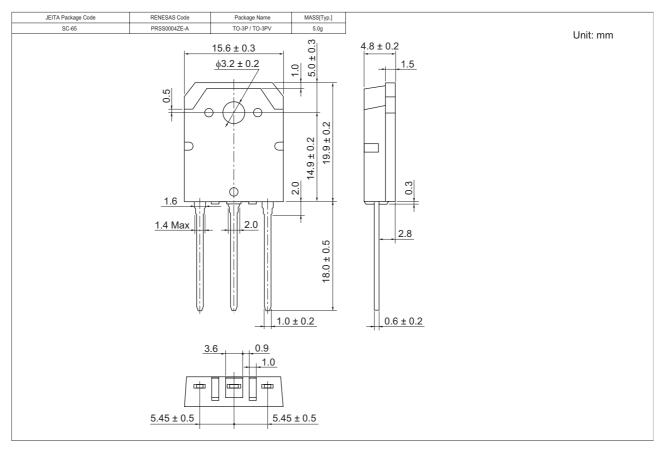






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# Package Dimensions



### **Ordering Information**

| Part Name | Quantity | Shipping Container |
|-----------|----------|--------------------|
| 2SK1303-E | 30 pcs   | Plastic magazine   |

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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